TSV911-TSV912-TSV914

Rail-to-rail input/output 8 MHz operational amplifiers

Features

- Rail-to-rail input and output
- Wide bandwidth
- Low power consumption: 1.1 mA max.
- Unity gain stability
- High output current: 35 mA
- Operating from 2.5 V to 5.5 V
- Low input bias current, 1 pA typ
- ESD internal protection ≥ 5 kV
- Latch-up immunity

Applications

- Battery-powered applications
- Portable devices
- Signal conditioning
- Active filtering
- Medical instrumentation
- Automotive applications

Description

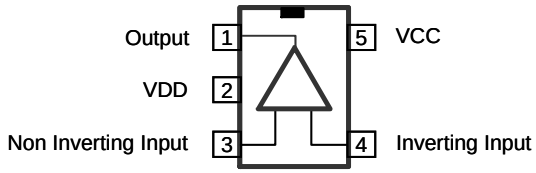
The TSV911/2/4 family of single, dual and quad operational amplifiers offers low voltage operation and rail-to-rail input and output.

This family features an excellent speed/power consumption ratio, offering an 8 MHz gain-bandwidth product while consuming only 1.1 mA max at 5 V supply voltage. These op-amps are unity gain stable for capacitive loads up to 200 pF. They also feature an ultra-low input bias current.

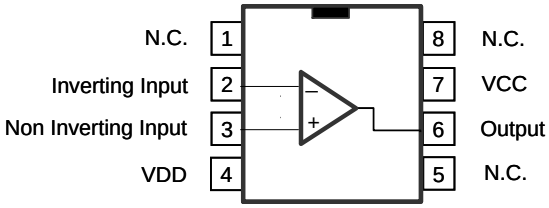
These characteristics make the TSV911/2/4 family ideal for sensor interfaces, battery-supplied and portable applications, as well as active filtering.

Pin connections
(top view)

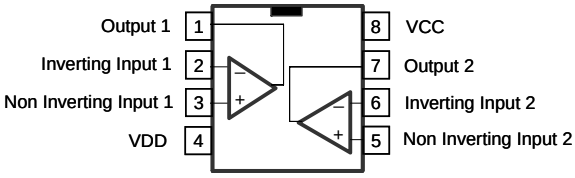
SOT23-5



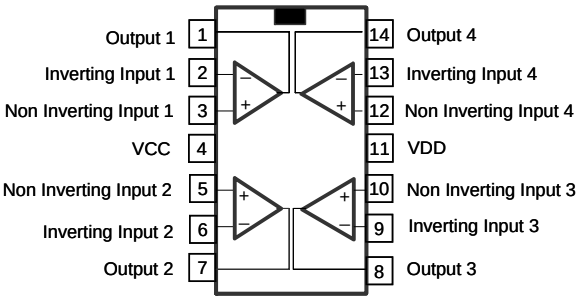
SO-8 (single)



MiniSO-8, SO-8 (dual)



SO-14, TSSOP14



1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings (AMR)

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage(1)	6	V
V_{id}	Differential input voltage (2)	$\pm V_{CC}$	V
V_{in}	Input voltage (3)	V_{DD}-0.2 to V_{CC}+0.2	V
T_{stg}	Storage temperature	-65 to +150	°C
R_{thja}	Thermal resistance junction to ambient(4) (5) SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	 250 125 190 103 100	°C/W
R_{thjc}	Thermal resistance junction to case(4) (5) SOT23-5 SO-8 MiniSO-8 SO-14 TSSOP14	 81 40 39 31 32	°C/W
T_j	Maximum junction temperature	150	°C
ESD	HBM: human body model(6)	5	kV
	MM: machine model(7)	300	V
	CDM: charged device model(8) SOT23-5, SO-8, MiniSO-8 TSSOP14 SO-14	 1500 750 500	V
	Latch-up immunity	200	mA

1. All voltage values, except differential voltage are with respect to network ground terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
3. V_{CC}-V_{in} must not exceed 6V.
4. Short-circuits can cause excessive heating and destructive dissipation.
5. R_{th} are typical values.
6. Human body model: A 100pF capacitor is charged to the specified voltage, then discharged through a 1.5kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
7. Machine model: A 200pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5Ω). This is done for all couples of connected pin combinations while the other pins are floating.
8. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to the ground through only one pin. This is done for all pins.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.5 to 5.5	V
V_{icm}	Common mode input voltage range	V_{DD} -0.1 to V_{CC} +0.1	V
T_{oper}	Operating free air temperature range	-40 to +125	°C

2 Electrical characteristics

Table 3. Electrical characteristics at V_{CC} = +2.5V with V_{DD} = 0V, V_{icm} = V_{CC}/2, R_L connected to V_{CC}/2, full temperature range (unless otherwise specified)(1)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{io}	Offset voltage TSV91x	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	0.1 -	4.5 7.5	mV
	TSV91xA	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	- -	1.5 3	
DV_{io}/DT	Input offset voltage drift		-	2	-	µV/°C
I_{io}	Input offset current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1 -	10(2) 100	pA
I_{ib}	Input bias current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1 -	10(2) 100	pA
CMR	Common mode rejection ratio 20 log ($\Delta V_{ic}/\Delta V_{io}$)	0V to 2.5V, V_{out} = 1.25V	58	75	-	dB
A_{vd}	Large signal voltage gain	R_L= 10kΩ, V_{out}= 0.5V to 2V, T= 25°C $T_{min} < T_{op} < T_{max}$	80 75	89 -	-	dB
V_{CC}-V_{OH}	High level output voltage	R_L = 10kΩ R_L = 600Ω		15 45	40 150	mV
V_{OL}	Low level output voltage	R_L = 10kΩ R_L = 600Ω	-	15 45	40 150	mV
I_{out}	I_{sink}	V_o = 2.5V, T= 25°C $T_{min} < T_{amb} < T_{max}$	18 16	32 -	- -	mA
	I_{source}	V_o = 0V, T= 25°C $T_{min} < T_{amb} < T_{max}$	18 16	35 -	- -	
I_{CC}	Supply current (per operator)	No load, V_{out}=V_{CC}/2	-	0.78	1.1	mA
AC performance						
GBP	Gain bandwidth product	R_L= 2kΩ, C_L=100pF, f =100kHz, T=25°C	-	8	-	MHz
F_u	Unity gain frequency	R_L= 2kΩ, C_L= 100pF, T= 25°C		7.2		MHz
ϕm	Phase margin	R_L= 2kΩ, C_L= 100pF, T= 25°C	-	45	-	Degrees
G_m	Gain margin	R_L= 2kΩ, C_L= 100pF, T= 25°C	-	8	-	dB
SR	Slew rate	R_L= 2kΩ, C_L=100pF, A_V=1, T= 25°C	-	4.5	-	V/µs
e_n	Equivalent input noise voltage	f= 10kHz, T= 25°C	-	21	-	$\frac{nV}{\sqrt{Hz}}$
THD+e_n	Total harmonic distortion	G=1, f=1kHz, R_L=2kΩ, Bw= 22kHz, T=25°C, V_{icm}=(V_{CC}+1)/2, V_{out}=1.1V_{pp}	-	0.001	-	%

1. All parameter limits at temperatures other than 25°C are guaranteed by correlation.
2. Guaranteed by design.

Table 4. Electrical characteristics at V_{CC} = +3.3V with V_{DD} = 0V, V_{icm} = V_{CC}/2, R_L connected to V_{CC}/2, full temperature range (unless otherwise specified)(1)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{io}	Offset voltage TSV91x	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	0.1 -	4.5 7.5	mV
	TSV91xA	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	- -	1.5 3	
DV_{io}	Input offset voltage drift		-	2	-	µV/°C
I_{io}	Input offset current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1 -	10(2) 100	pA
I_{ib}	Input bias current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1	10(2) 100	pA
CMR	Common mode rejection ratio 20 log ($\Delta V_{ic}/\Delta V_{io}$)	0V to 3.3V, V_{out} = 1.65V	60	78	-	dB
A_{vd}	Large signal voltage gain	R_L=10kΩ, V_{out}= 0.5V to 2.8V, T=25°C $T_{min} < T_{op} < T_{max}$	80 75	90	-	dB
V_{CC}-V_{OH}	High level output voltage	R_L = 10kΩ R_L = 600Ω		15 45	40 150	mV
V_{OL}	Low level output voltage	R_L = 10kΩ R_L = 600Ω	-	15 45	40 150	mV
I_{out}	I_{sink}	V_o = 3.3V, T= 25°C $T_{min} < T_{amb} < T_{max}$	18 16	32 -	- -	mA
	I_{source}	V_o = 0V, T= 25°C $T_{min} < T_{amb} < T_{max}$	18 16	35 -	- -	
I_{CC}	Supply current (per operator)	No load, V_{out}=V_{CC}/2	-	0.8	1.1	mA
AC performance						
GBP	Gain bandwidth product	R_L= 2kΩ, C_L= 100pF, f = 100kHz, T= 25°C	-	8	-	MHz
F_u	Unity gain frequency	R_L= 2kΩ, C_L=100pF, T= 25°C	-	7.2	-	MHz
ϕm	Phase margin	R_L= 2kΩ, C_L=100pF, T= 25°C	-	45	-	Degrees
G_m	Gain margin	R_L= 2kΩ, C_L=100pF, T= 25°C	-	8	-	dB
SR	Slew rate	R_L= 2kΩ, C_L= 100pF, A_v=1, T= 25°C	-	4.5	-	V/µs
e_n	Equivalent input noise voltage	f= 10kHz, T= 25°C	-	21	-	$\frac{nV}{\sqrt{Hz}}$
THD+e_n	Total harmonic distortion	G=1, f=1kHz, R_L=2kΩ, BW= 22kHz, V_{icm}=(V_{CC}+1)/2, V_{out}=1.9V_{pp}, T=25°C	-	0.0007	-	%

1. All parameter limits at temperatures other than 25°C are guaranteed by correlation.
2. Guaranteed by design.

Table 5. Electrical characteristics at V_{CC} = +5V with V_{DD} = 0V, V_{icm} = V_{CC}/2, R_L connected to V_{CC}/2, full temperature range (unless otherwise specified)(1)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{io}	Offset voltage TSV91x	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	0.1 -	4.5 7.5	mV
	TSV91xA	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	- -	1.5 3	
DV_{io}	Input offset voltage drift		-	2	-	µV/°C
I_{io}	Input offset current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1 -	10(2) 100	pA
I_{ib}	Input bias current	T= 25°C $T_{min} < T_{op} < T_{max}$	- -	1 -	10(2) 100	pA
CMR	Common mode rejection ratio 20 log ($\Delta V_{ic}/\Delta V_{io}$)	0V to 5V, V_{out} = 2.5V	62	82	-	dB
SVR	Supply voltage rejection ratio 20 log ($\Delta V_{CC}/\Delta V_{io}$)	V_{CC} = 2.5 to 5V	70	86	-	dB
A_{vd}	Large signal voltage gain	R_L=10kΩ, V_{out}= 0.5V to 4.5V, T= 25°C $T_{min} < T_{op} < T_{max}$	80 75	91	-	dB
V_{CC}-V_{OH}	High level output voltage	R_L = 10kΩ R_L = 600Ω		15 45	40 150	mV
V_{OL}	Low level output voltage	R_L = 10kΩ R_L = 600Ω	-	15 45	40 150	mV
I_{out}	I_{sink}	V_o = 5V, T=25°C $T_{min} < T_{amb} < T_{max}$	18 16	32 -	- -	mA
	I_{source}	V_o = 0V, T= 25°C $T_{min} < T_{amb} < T_{max}$	18 16	35 -	- -	
I_{CC}	Supply current (per operator)	No load, V_{out}= 2.5V	-	0.82	1.1	mA
AC performance						
GBP	Gain bandwidth product	R_L= 2kΩ, C_L= 100pF, f = 100kHz, T=25°C	-	8	-	MHz
F_u	Unity gain frequency	R_L = 2kΩ, C_L=100pF, T= 25°C	-	7.5	-	MHz
ϕm	Phase margin	R_L = 2kΩ, C_L=100pF, T= 25°C	-	45	-	Degrees
G_m	Gain margin	R_L = 2kΩ, C_L=100pF, T= 25°C	-	8	-	dB
SR	Slew rate	R_L= 2kΩ, C_L= 100pF, A_V = 1, T= 25°C	-	4.5	-	V/µs
e_n	Equivalent input noise voltage	f=1kHz, T= 25°C f=10kHz, T= 25°C	- -	27 21	- -	$\frac{nV}{\sqrt{Hz}}$
THD+e_n	Total harmonic distortion	G=1, f=1kHz, R_L=2kΩ, Bw= 22kHz, T=25°C, V_{icm}=(V_{CC}+1)/2, V_{out}=3.6V_{pp}	-	0.0004	-	%

1. All parameter limits at temperatures other than 25°C are guaranteed by correlation.
2. Guaranteed by design.

Figure 1. Input offset voltage distribution at T= 25°C

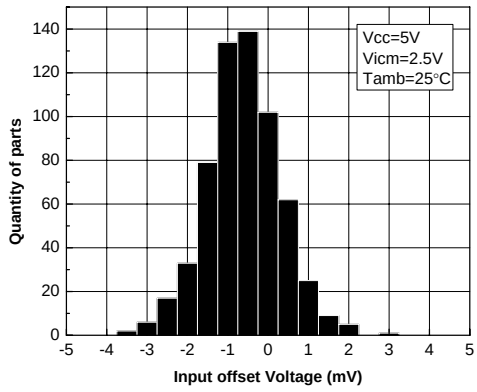


Figure 2. Input offset voltage distribution at T= 125°C

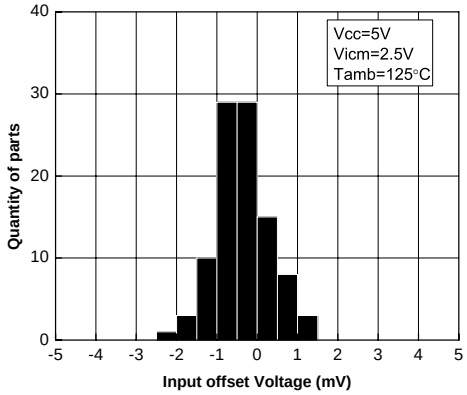


Figure 3. Supply current vs. input common mode voltage at V_{CC}= 2.5V

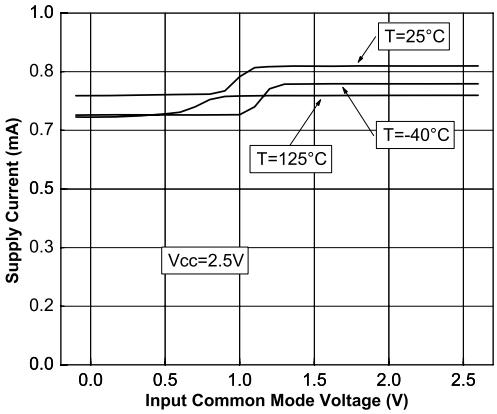


Figure 4. Supply current vs. input common mode voltage at V_{CC}= 5V

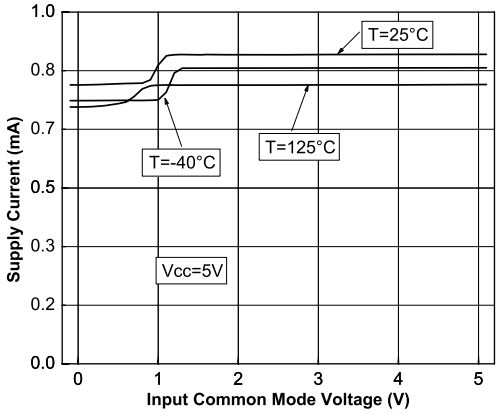


Figure 5. Output current vs. output voltage at V_{CC}= 2.5V

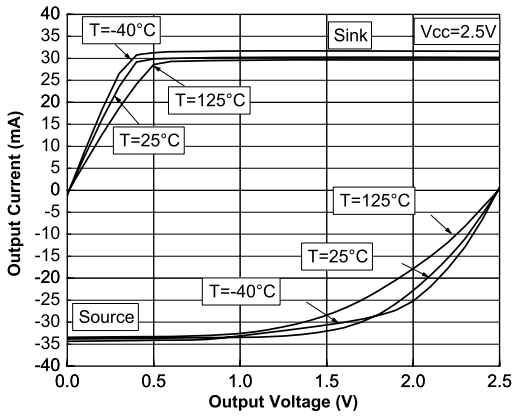


Figure 6. Output current vs. output voltage at V_{CC}= 5V

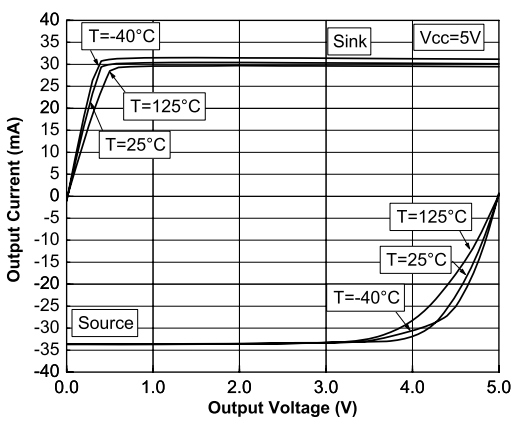


Figure 7. Voltage gain and phase vs frequency at V_{CC}= 2.5V and V_{icm}= 0.5V

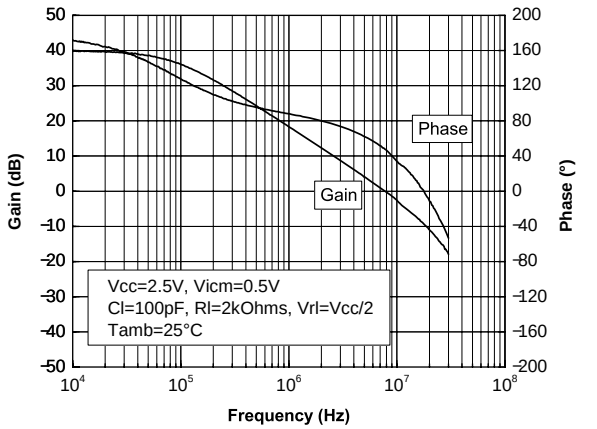


Figure 8. Voltage gain and phase vs frequency at V_{CC}= 5.5V and V_{icm}= 0.5V

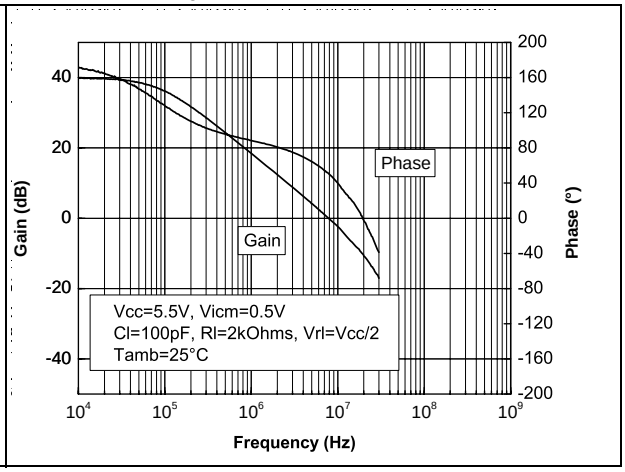


Figure 9. Phase margin vs.capacitive load

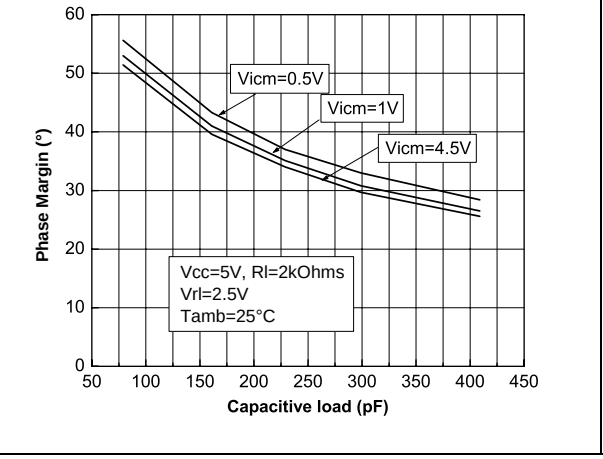


Figure 10. Phase margin vs.output current

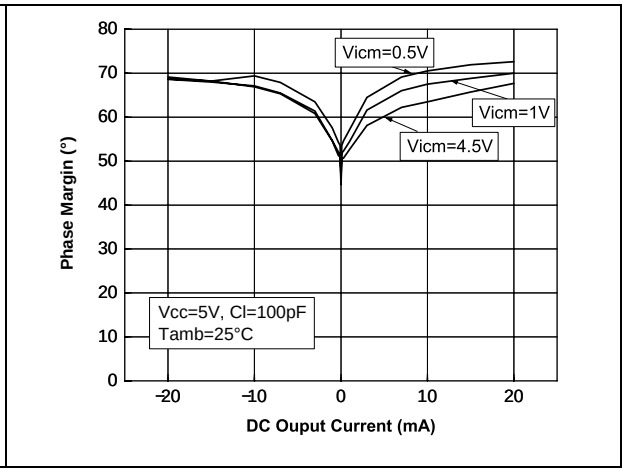


Figure 11. Positive slew rate

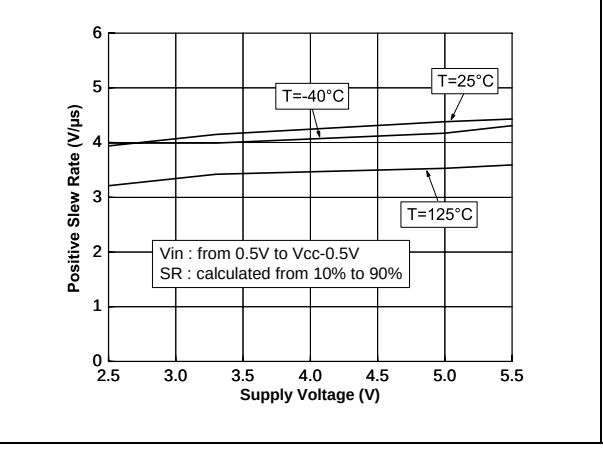


Figure 12. Negative slew rate

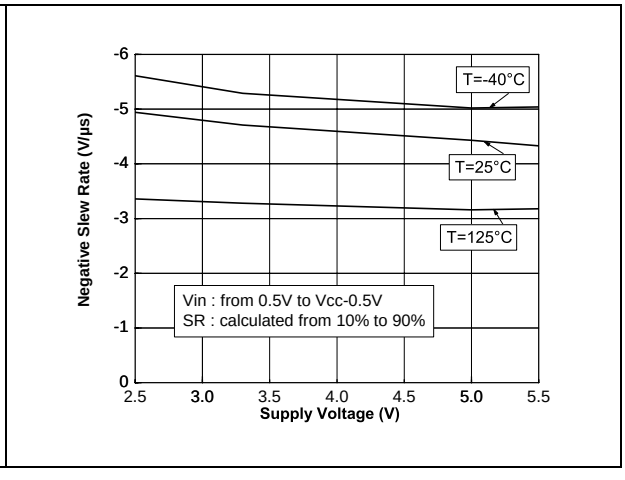


Figure 13. Distorsion + noise vs. frequency

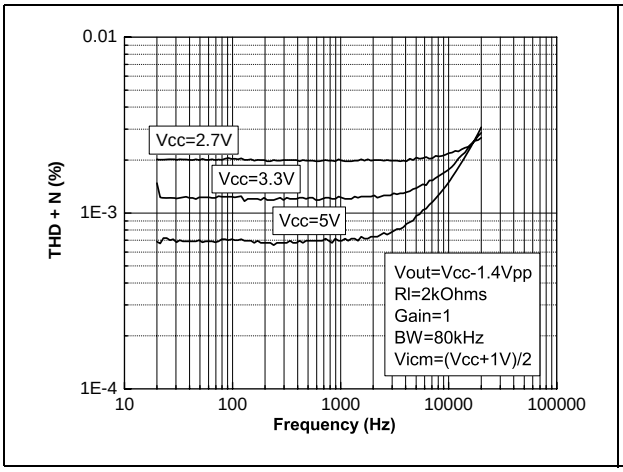


Figure 14. Distorsion + noise vs. output voltage

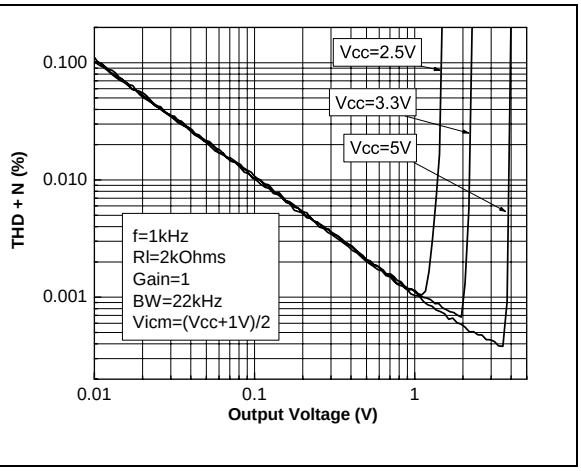


Figure 15. Noise vs. frequency

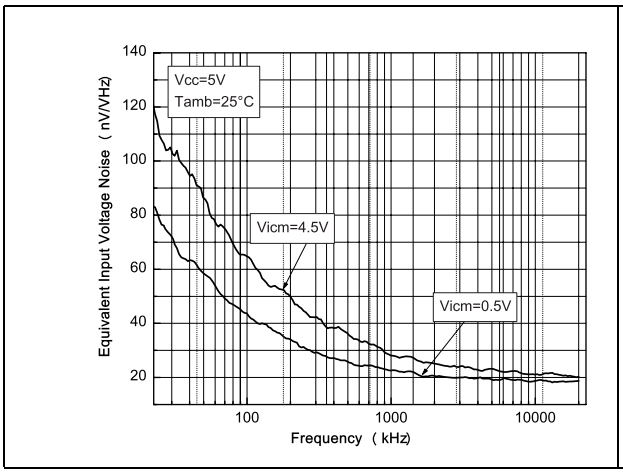
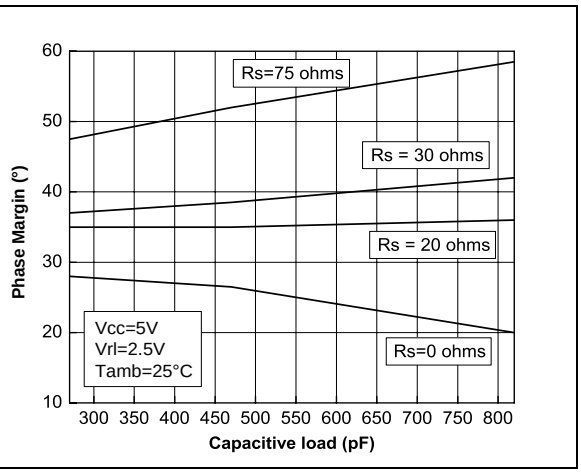


Figure 16. Phase margin vs. capacitive load and serial resistor



3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

Note: All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.

3.1 SOT23-5 package information

Figure 17. SOT23-5 package mechanical drawing

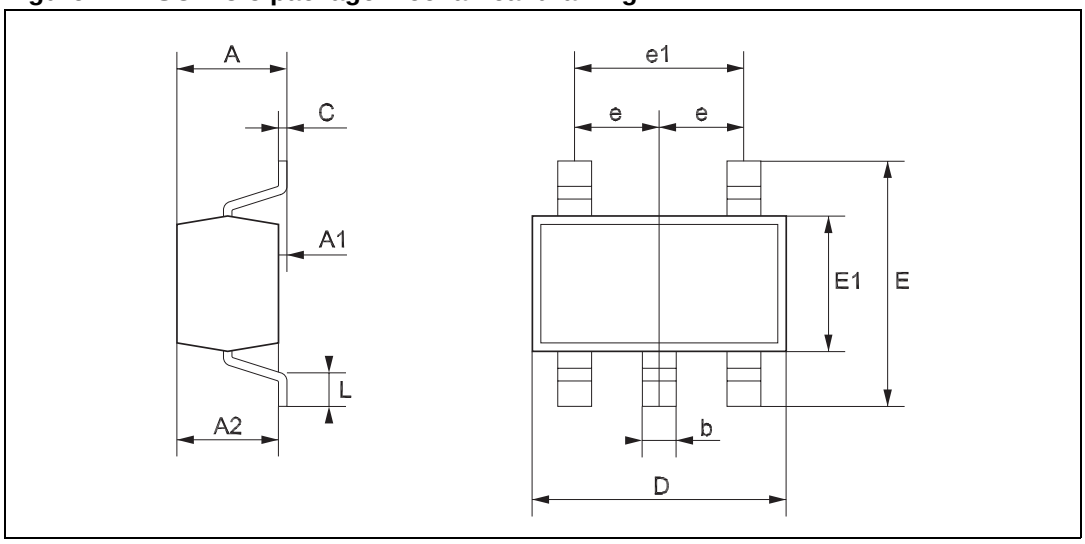


Table 6. SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6

3.2 MiniSO-8 package information

Figure 18. MiniSO-8 package mechanical drawing

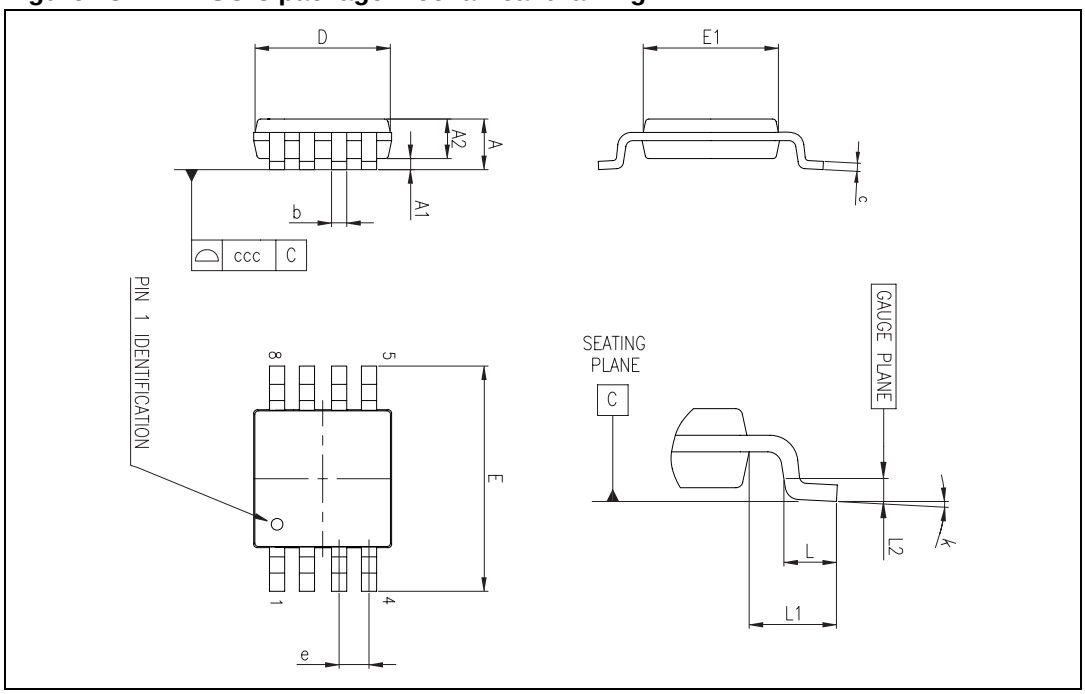


Table 7. MiniSO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.030	0.033	0.037
b	0.22		0.40	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.80	3.00	3.20	0.11	0.118	0.126
E	4.65	4.90	5.15	0.183	0.193	0.203
E1	2.80	3.00	3.10	0.11	0.118	0.122
e		0.65			0.026	
L	0.40	0.60	0.80	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.010	
k	0°		8°	0°		8°
ccc			0.10			0.004

3.3 SO-8 package information

Figure 19. SO-8 package mechanical drawing

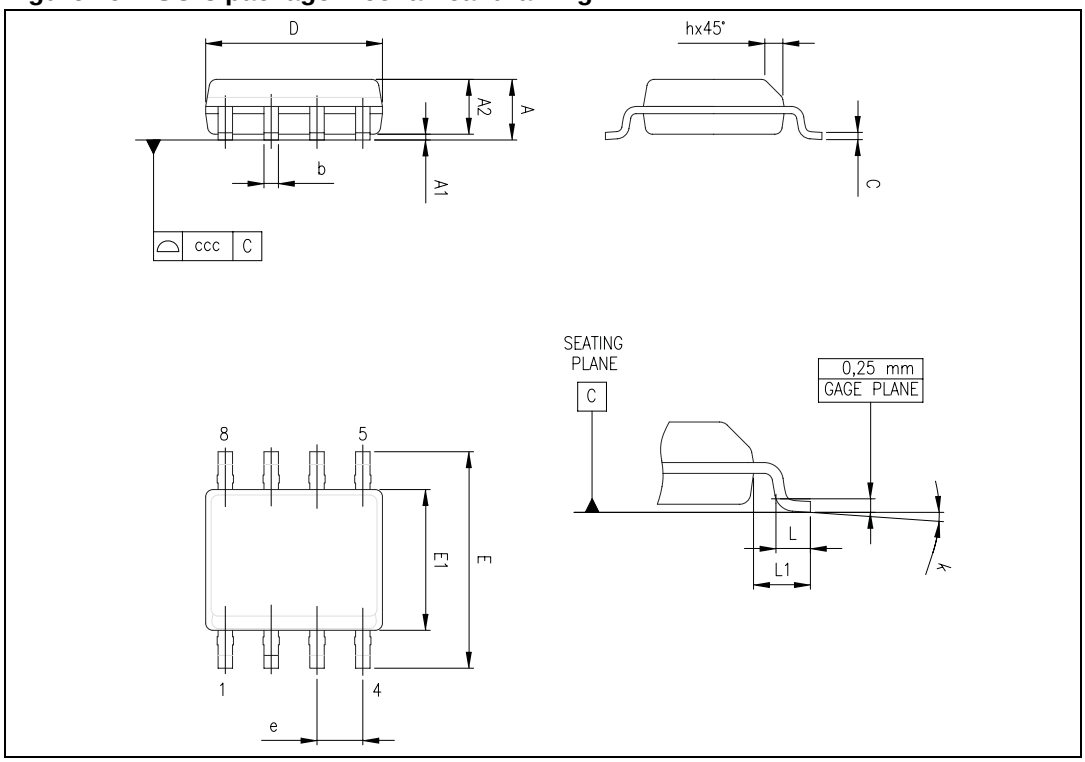


Table 8. SO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

3.4 TSSOP14 package information

Figure 20. TSSOP14 package mechanical drawing

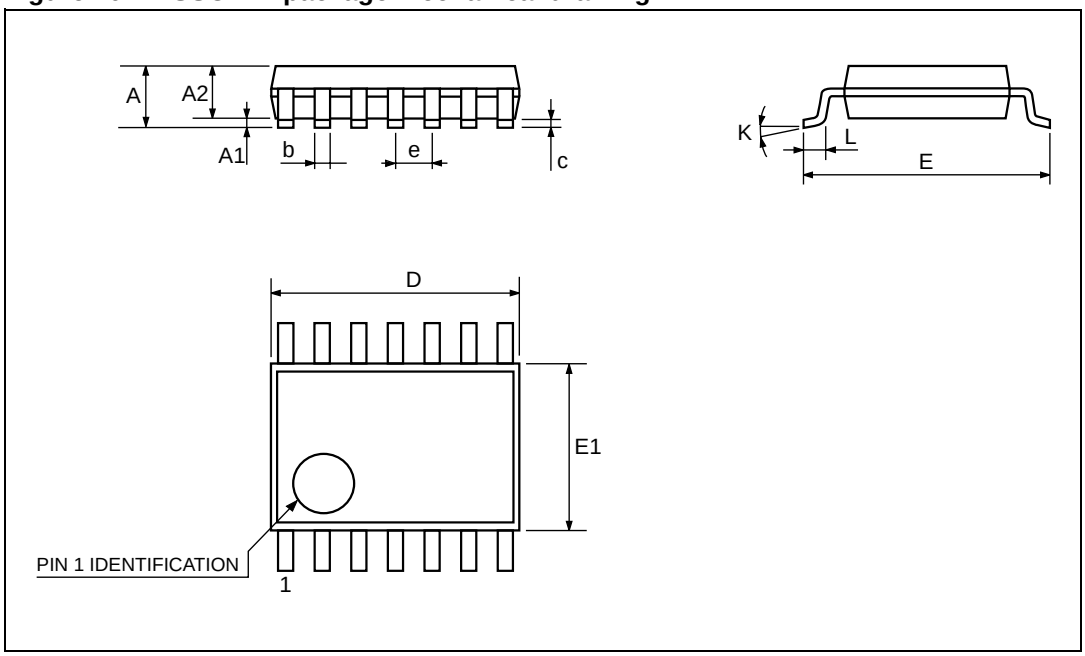


Table 9. TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L1	0.45	0.60	0.75	0.018	0.024	0.030

3.5 SO-14 package information

Figure 21. SO-14 package mechanical drawing

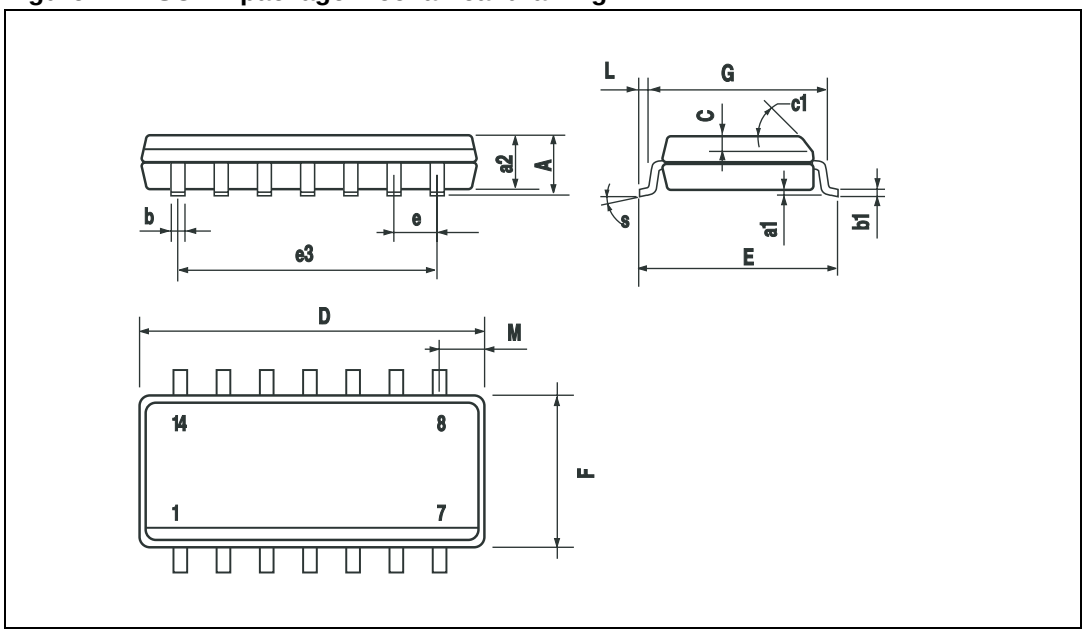


Table 10. SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					

4 Ordering information

Table 11. Order codes[1]

Order code	Temperature range	Package	Packing	Marking
TSV911ID TSV911IDT	-40°C to +125°C	SO-8	Tube o Tape & reel	V911I
TSV911AID TSV911AIDT				V911AI
TSV911ILT		SOT23-5	Tape & reel	K127
TSV911AILT				K128
TSV912IST		MiniSO-8		K125
TSV912AIST				K126
TSV912ID TSV912IDT		SO-8	Tube or Tape & reel	V912I
TSV912AID TSV912AIDT				V912AI
TSV914IPT		TSSOP14	Tape & reel	V914I
TSV914AIPT				V914AI
TSV914ID TSV914IDT		SO-14[1]	Tube or Tape & reel	V914I
TSV914AID TSV914AIDT				V914AI
TSV911IYD[2] TSV911IYDT[2]		SO-8 Automotive grade level		V911IY
TSV911AIYD[2] TSV911AIYDT[2]				V911AY
TSV912IYD[2] TSV912IYDT[2]				V912IY
TSV912AIYD[2] TSV912AIYDT[2]				V912AY
TSV914IYD[2] TSV914IYDT[2]		SO-14[1] Automotive grade level		V914IY
TSV914AIYD[2] TSV914AIYDT[2]				V914AY

1. All packages are Moisture Sensitivity Level 1 as per Jedec J-STD-020-C, except SO-14 which is Jedec level 3.
2. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent are on-going.

5 Revision history

Table 12. Document revision history

Date	Revision	Changes
28-Aug-2006	1	First release.
07-Jun-2007	2	Modified ESD CDM parameter for SO-14 package in *Table 1: Absolute maximum ratings (AMR)*. Noise parameters updated in *Section 2: Electrical characteristics*. Added limits in temperature in *Section 2: Electrical characteristics*. Added automotive grade level description in *Table 11: Order codes*. Added footnote about SO-14 package in *Table 11: Order codes*. Added *Figure 16: Phase margin vs. capacitive load and serial resistor*.
11-Feb-2008	3	Updated footnotes for ESD parameters in *Table 1: Absolute maximum ratings (AMR)*. Corrected MiniSO-8 package information in *Table 7: MiniSO-8 package mechanical data*. Added missing markings for order codes TSV911AILT and TSV912AILT in *Table 11: Order codes*.

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